# 504998635 07/11/2018

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT	
CONVEYING PARTY D	ΑΤΑ			
		Name	Execution Date	
BHUPENDRA KUMAR SONI			07/03/2018	
BROOKS JOHN KELLY			07/09/2018	
JAMES PATRICK LANGAN			07/03/2018	
HUNTINGTON DAVIS			07/07/2018	
ALAN D. HAHN			07/10/2018	
RECEIVING PARTY DA	ТА			
Name:	MYCOTECHNOLOGY, INC.			
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City:	AURORA			
State/Country:	COLORADO			
Postal Code:	80011			
PROPERTY NUMBERS Total: 1 Property Type		Number		
Application Number: 16		16025365		
CORRESPONDENCE D	ΑΤΑ			
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		the e-mail address first; if that is un		
<i>using a fax number, if</i> Phone:		l <b>; if that is unsuccessful, it will be se</b> 7207957976	nt via US Mail.	
Email:		assignments@leydig.com, tsharp@leyd	dia.com	
Correspondent Name:	LEYDIG, VOIT & MAYER, LTD.			
Address Line 1:	4875 PEARL EAST CIRCLE, SUITE 301			
Address Line 4:	BOULDER, COLORADO 80301			
ATTORNEY DOCKET N	JMBER:	0640.22US-2	0640.22US-2	
NAME OF SUBMITTER:		MARY BREEN SMITH	MARY BREEN SMITH	
SIGNATURE:		/Mary Breen Smith/	/Mary Breen Smith/	
DATE SIGNED:		07/11/2018	07/11/2018	
Total Attachments: 4				

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### ASSIGNMENT

WHEREAS, I/WE:

- Assignor: Bhupendra Kumar SONI, residing at 4255 Kittredge Street, Apt. 216, Denver, CO 80239 USA;
- 2. Assignor: Brooks John KELLY, residing at 13243 Lackland Drive, Denver, CO 80239 USA:
- 3. Assignor: James Patrick LANGAN, residing at 1955 Ulster Street, Unit 410, Denver, CO 80220;
- 4. Assignor: Huntington DAVIS, residing at 401 Interlocken Drive, #6302, Broomfield, CO 80021;
- 5. Assignor: Alan D. HAHN, residing at 25 Tigenily Drive, Lake Forest, CA 92630;

herein called individually an "ASSIGNOR" and collectively "ASSIGNORS," in connection with the invention entitled:

"Methods for the Production and Use of Mycellated High Protein Food Compositions";

for which the following patent application(s):

Country	Application Serial No.	Filing Date
US	16/025,365	July 2, 2018

was/were submitted or filed (collectively, the "LISTED APPLICATION(S)"):

AND WHEREAS, Assignee: MycoTechnology, Inc.

(herein called "ASSIGNEE"), an entity organized and existing under the laws of the State of Colorado, having a principal place of business at:

3155 N. Chambers Rd., Suite E Aurora, CO 80011,

is desirous of obtaining my/our entire right, title and interest in, to and under the said invention and the said LISTED APPLICATION(S);

NOW, THEREFORE, in consideration of my contractual and other legal obligations, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, a said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the invention(s) and discoveries disclosed in the LISTED APPLICATION(S), and the LISTED APPLICATION(S) and all divisions, renewals, continuations and subsequent applications thereof, and all Patents of the United States which may be granted thereon and all reissues, reexaminations, and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may

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PATENT REEL: 046319 FRAME: 0941

### LVM Docket No. 330780: 0640.22US-2 Assignment

hereafter be filed for said invention(s) and discoveries in any country or countries foreign to the United States; together with the right to file such applications and the right to claim for the same the benefit of priority of said inventions, discoveries, and patent applications listed herein, including the LISTED APPLICATION(S) and applications thereof and therefrom under The International Union for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application and applications thereof and therefrom is/are filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention(s) in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and any and all claims, causes of action, and damages for past, present, and future infringement or other unauthorized use of the above items, along with the right to sue for and to collect damages and other relief;

AND I HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY authorize the above-mentioned ASSIGNEE or its legal representative to insert in this instrument the filing date and serial number of said application(s) or any other information that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention(s) and discoveries, and testify in any legal proceeding, sign all lawful papers, execute all continuing and subsequent applications, including divisional, reissue and foreign applications, make all rightful oaths, and generally cooperate and do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain, maintain, and enforce proper protection for said invention(s) and discoveries in any and all countries;

AND I HEREBY further agree that this Assignment does not create any agency, employment, or partnership relationship between the parties;

AND I HEREBY further agree that this Assignment shall not be construed against any party on the ground that such party was responsible for the preparation of this Assignment, or on any related ground;

AND I HEREBY further agree that should any provision of this Assignment be determined to be void, unenforceable, or against public policy, such provision may altered in time or scope in order to give effect to such provision. If such alternation is not possible, such provision shall be deemed severed from this Assignment and the balance of this Assignment shall remain in full force and effect, so long as the original intent of this Assignment remains substantially intact.

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# LVM Docket No. 330780: 0640.22US-2 Assignment

IN TESTIMONY WHEREOF, I hereunto set my hand and seal (if applicable) the day and year set opposite my signature.

(sign)

Assignor 1: July 3, 2018 Date

SAM

Bhupendra Kumar SONI

# Assignor 2:

7.9.18

Date

(sign) Brooks

## Assignor 3:

Date

(sign) James Patrick LANGAN

# Assignor 4:

12018 Date

(sign)

**Huntington DAVIS** 

# Assignor 5:

2018

(sign)

Alan D. HAHN

Additional Assignors on additional sheets: No

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PATENT REEL: 046319 FRAME: 0943 Assignee: MycoTechnology, Inc.

7/6/2015 Date

(sign) (print full name) Alan Haha

(title) \_\_\_\_\_\_\_

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**RECORDED: 07/11/2018**